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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10013103	FILING DATE 11/06/2001	CLASS 257 703	SUBCLASS 640	GAU 2822
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EXAMINER
Lewis

**APPLICANTS: Seshan Krishna; Dass M.; Bakker Geoffrey

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A DIV OF 09/105,590 06/26/1998

** FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged: Examiners's initials	<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO 42390P5778D	
TITLE : Semiconductor passivation deposition process for interfacial adhesion U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)			

NOTICE OF ALLOWANCE MAILED 11/06/2001		CLAIMS ALLOWED	
Primary Examiner Assistant Examiner		Total Claims Independent Claims Drawing Sheets Drawings Page Drawings Priority	
ISSUE FEE PAID Amount Due Date Paid		Primary Examiner Application Examiner	
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